

LNPTM THERMOCOMPTM COMPOUND NX11302

DESCRIPTION

LNP THERMOCOMP NX11302 compound is based on Polycarbonate/Acrylonitrile Butadiene Styrene (PC/ABS) blend containing proprietary fillers. Added features of this grade include: Colorable, Improved Plating Surface and Mechanical Performance targeted for Laser Direct Structuring (LDS) applications.

GENERAL INFORMATION	
Features	Dielectrics, Laser Direct Structuring, No PFAS intentionally added
Fillers	Unreinforced
Polymer Types	Polycarbonate + ABS (PC+ABS)
Processing Techniques	Injection Molding

INDUSTRY	SUB INDUSTRY
Automotive	Automotive Interiors
Consumer	Personal Accessory
Electrical and Electronics	Mobile Phone - Computer - Tablets
Industrial	Electrical

TYPICAL PROPERTY VALUES

Revision 20231109

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL (1)			
Tensile Stress, yld, Type I, 50 mm/min	47	MPa	ASTM D638
Tensile Stress, brk, Type I, 50 mm/min	46	MPa	ASTM D638
Tensile Strain, yld, Type I, 50 mm/min	4.6	%	ASTM D638
Tensile Strain, brk, Type I, 50 mm/min	75	%	ASTM D638
Tensile Modulus, 50 mm/min	2350	MPa	ASTM D638
Flexural Stress, yld, 1.3 mm/min, 50 mm span	79	MPa	ASTM D790
Flexural Stress, brk, 1.3 mm/min, 50 mm span	78	MPa	ASTM D790
Flexural Modulus, 1.3 mm/min, 50 mm span	2230	MPa	ASTM D790
IMPACT (1)			
Izod Impact, notched, 23°C	550	J/m	ASTM D256
THERMAL (1)			
HDT, 1.82 MPa, 3.2mm, unannealed	106	°C	ASTM D648
CTE, -40°C to 40°C, flow	7.1E-05	1/°C	ASTM E831
CTE, -40°C to 40°C, xflow	7.6E-05	1/°C	ASTM E831
Relative Temp Index, Elec ⁽²⁾	60	°C	UL 746B
Relative Temp Index, Mech w/impact (2)	60	°C	UL 746B
Relative Temp Index, Mech w/o impact ⁽²⁾	60	°C	UL 746B
PHYSICAL (1)			
Density	1.22	g/cm³	ASTM D792
Water Absorption, (23°C/24hrs)	0.01	%	ASTM D570
Moisture Absorption, (23°C/50% RH/24 hrs)	0.01	%	ASTM D570



PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
Mold Shrinkage, flow, 24 hrs ⁽³⁾	0.6	%	ASTM D955
Mold Shrinkage, xflow, 24 hrs ⁽³⁾	0.6	%	ASTM D955
Melt Volume Rate, MVR at 260°C/5.0 kg	14	cm³/10 min	ISO 1133
ELECTRICAL (1)			
Relative Permittivity, 1 GHz	2.94	-	IEC 60250
Dissipation Factor, 1 GHz	0.0057	-	IEC 60250
FLAME CHARACTERISTICS (2)			
UL Yellow Card Link	E207780-100974177	-	
UL Recognized, 94HB Flame Class Rating	≥0.6	mm	UL 94
INJECTION MOLDING (4)			
Drying Temperature	85 – 95	°C	
Drying Time	2 – 4	Hrs	
Drying Time (Cumulative)	8	Hrs	
Maximum Moisture Content	0.01	%	
Melt Temperature	220 – 260	°C	
Nozzle Temperature	220 – 260	°C	
Front - Zone 3 Temperature	215 – 255	°C	
Middle - Zone 2 Temperature	215 – 255	°C	
Rear - Zone 1 Temperature	200 – 250	°C	
Mold Temperature	40 – 75	°C	
Back Pressure	0.5 – 0.9	MPa	
Screw Speed	50 – 100	rpm	
Shot to Cylinder Size	50 – 70	%	
Vent Depth	0.038 – 0.051	mm	

- (1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.
- (2) UL Ratings shown on the technical datasheet might not cover the full range of thicknesses and colors. For details, please see the UL Yellow Card.
- (3) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.
- (4) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

MORE INFORMATION

For curve data and CAE cards, please visit and register at https://materialfinder.sabic-specialties.com

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